

Title (en)
HEAT FLOW DEVICE

Title (de)
WÄRMEÜBERTRAGER

Title (fr)
DISPOSITIF A ECOULEMENT DE CHALEUR

Publication
EP 2047201 B1 20210901 (FR)

Application
EP 07823290 A 20070717

Priority
• FR 2007001223 W 20070717
• FR 0653016 A 20060718

Abstract (en)
[origin: WO2008009812A1] A device comprises equipment (101) with a heat source, a cold part (102) relative to the equipment, and a thermal conductor element (103) capable of conducting the heat from the equipment to the cold part. The element (103) is such that, under certain thermal conditions above a given thermal condition, the equipment and the cold part are essentially thermally isolated.

IPC 8 full level
F28F 13/00 (2006.01)

CPC (source: EP US)
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WO 2008009812 A1 20080124; BR PI0713191 A2 20120320; CA 2657778 A1 20080124; CA 2657778 C 20151124; CN 101490497 A 20090722; CN 101490497 B 20140723; EP 2047201 A1 20090415; EP 2047201 B1 20210901; FR 2904103 A1 20080125; FR 2904103 B1 20150515; JP 2009543998 A 20091210; RU 2009105501 A 20100827; RU 2460955 C2 20120910; US 2010012311 A1 20100121; US 2013098594 A1 20130425; US 9310145 B2 20160412

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